**AiT Semiconductor Inc.** 

Part Number

MMBT4401L

SPQ: 3,000pcs/Reel

## DESCRIPTION

Package Type

SOT-23

Note

The MMBT4401L is available in SOT-23 package.

AiT provides all RoHS Compliant Products

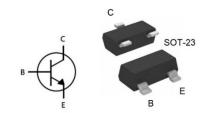
**ORDERING INFORMATION** 

www.ait-ic.com

# APPLICATION

- High Stability and High Reliability
- General Purpose Application
- Switching Application.

## PIN DESCRIPTION



PIN#	DESCRIPTION		
В	BASE		
E	EMITTER		
С	COLLECTOR		

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^{\circ}C$ , unless otherwise note	ed.	
V <sub>CEO</sub> , Collector–Emitter Voltage		40V
V <sub>CBO</sub> , Collector–Base Voltage		60V
V <sub>EBO</sub> , Emitter–Base Voltage		6V
Ic, Continuous Collector Current		600mA
P <sub>D</sub> , Total Device Dissipation	T <sub>A</sub> = 25°C	225mW
FR-5 Board <sup>(1)</sup>	Derate above 25°C	1.8 mW/°C
R <sub>eJA</sub> , Thermal Resistance, Junction-Ambient		556°C/W
P <sub>D</sub> , Total Device Dissipation	T <sub>A</sub> = 25°C	300mW
Alumina Substrate (2)	Derate above 25°C	<b>2.4 mW/</b> ℃
R <sub>0JA</sub> , Thermal Resistance, Junction-Ambient		417°C/W
T <sub>J</sub> , Operation Junction Temperature		-55°C~+150°C
T <sub>STG</sub> , Storage Temperature		-55°C~+150°C
Stresses above may cause permanent da	amage to the device. These are stress ratings only and	I functional operation of the device at these

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) FR-5=1.0x0.75x0.062 in.

(2) Alumina=0.4x0.3x0.024 in. 99.5% alumina.



# ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$ , unless otherwise noted.

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
OFF CHARACTERTICS						
Collector-Emitter * Breakdown Voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 1mA, I <sub>B</sub> = 0	40	-	-	V
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 0.1mA, I <sub>E</sub> = 0	60	-	-	V
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 0.1mA, I <sub>C</sub> = 0	6	-	-	V
Base Cutoff Current	IBEV	$V_{CE} = 35V, V_{EB} = 0.4V$	-	-	0.1	μA
Collector Cutoff Current	ICEX	$V_{CE} = 35V, V_{EB} = 0.4V$	-	-	0.1	μA
ON CHARACTERISTICS*						
		V <sub>CE</sub> = 1V, I <sub>C</sub> = 0.1mA	20	-	-	
		$V_{CE} = 1V$ , $I_C = 1mA$	40	-	-	
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> = 1V, I <sub>C</sub> = 10mA	80	-	-	
	TIFE	V <sub>CE</sub> = 1V, I <sub>C</sub> = 150mA	100	-	300	
		V <sub>CE</sub> = 2V, I <sub>C</sub> = 500mA	40	-	-	
Collector-Emitter		I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA	-	-	0.40	V
Saturation Voltage	V <sub>CE (sat)</sub>	$I_{\rm C}$ = 500mA, $I_{\rm B}$ = 50mA	-	-	0.75	v
Base-Emitter	V <sub>BE (sat)</sub>	I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA	0.75	-	0.95	V
Saturation Voltage	V BE (sat)	I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA	-	-	1.20	v
Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
SMALL-SIGNAL CHARACTE	ERISTICS					
Current-Gain Bandwidth Product	f⊤	V <sub>CE</sub> = 10V, I <sub>C</sub> = 20mA, f=100MHz	250	-	-	MHz
Collector-Base Capacitance	Ccb	$V_{CB}$ = 5V, I <sub>E</sub> = 0, f=1MHz	-	-	6.5	pF
Emitter-Base Capacitance	Ceb	$V_{EB}$ = 0.5V, I <sub>C</sub> = 0, f=1MHz	-	-	30	pF
Input Impedance	h <sub>ie</sub>	V <sub>CE</sub> = 10V, I <sub>C</sub> = 1mA, f=1kHz	1.0	-	15	kΩ
Voltage Feedback Ratio	h <sub>re</sub>	$V_{CE}$ = 10V, $I_{C}$ = 1mA, f=1kHz	0.1	-	8.0	X10-4
Small-Signal Current Gain	h <sub>fe</sub>	V <sub>CE</sub> = 10V, I <sub>C</sub> = 1mA, f=1kHz	40	-	500	-
Output Admittance	h <sub>oe</sub>	V <sub>CE</sub> = 10V, I <sub>C</sub> = 1mA, f=1kHz	1.0	-	30	µmhos
SWITCHING CHARACTERIS	STICS					
Delay Time	td	V <sub>CC</sub> =30V, V <sub>EB</sub> = 2V,	-	-	15	ns
Rise Time	tr	$I_{\rm C} = 150 \text{mA}, I_{\rm B1} = 15 \text{mA},$	-	-	20	
			t	1	005	
Storage Time	ts	V <sub>CC</sub> =30V, I <sub>C</sub> = 150mA,	-	-	225	ns

\*Pulse test: pulse width≤300us, duty cycle≤2.0%



## TYPICAL PERFORMANCE CHARACTERISTICS

Fig 1. Turn-On Time

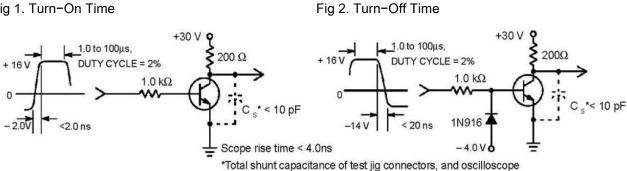


Fig 3. Capacitance

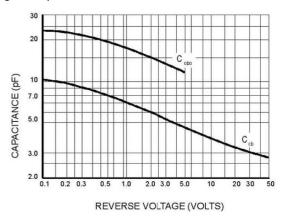


Fig 5. Turn-On Time

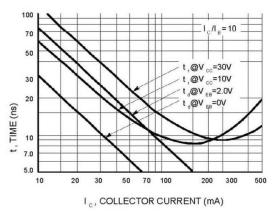
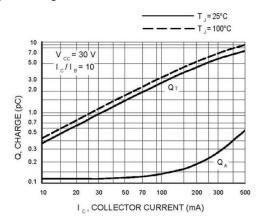
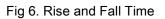
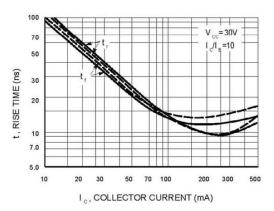


Fig 4. Charge Data









#### Fig 7. Storage Time

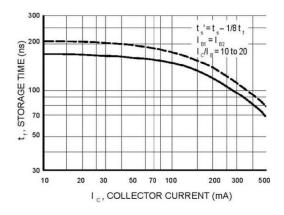


Fig 9. Frequency Effects

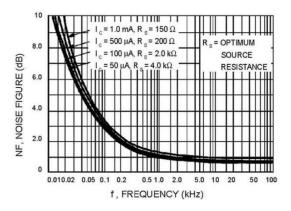


Fig 11. Current Gain

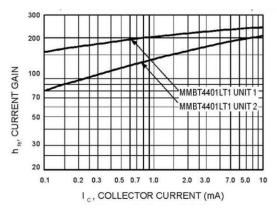


Fig 8. Fall Time

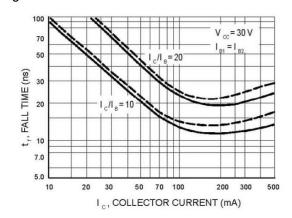


Fig 10. Source Resistance Effects

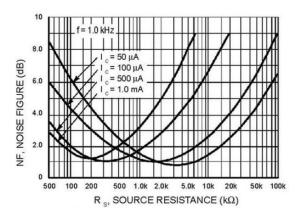
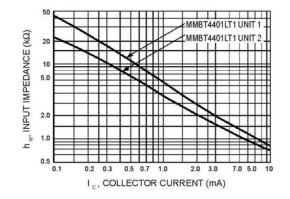


Fig 12. Impedance





VOLTAGE FEEDBACK RATIO (X 10 -4 ) 10 7.0 5.0 401LT MMBT4401LT1 UNIT 3.0 2.0 1.0 0.7 0.5 0.3 0.2 h re. 0.2 0.3 0.5 0.7 1.0 2.0 3.0 7.0 5.0 0.1 10 I c, COLLECTOR CURRENT (mA)

Fig 14. Output Admittance

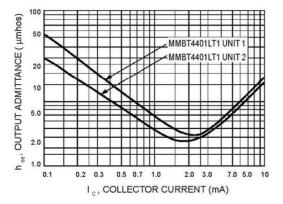
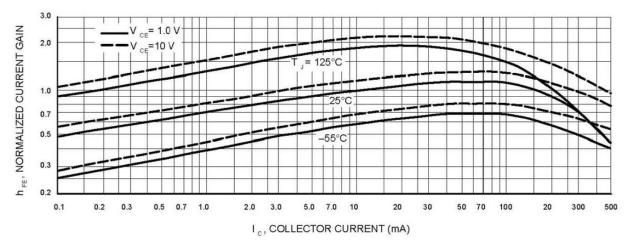
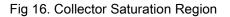
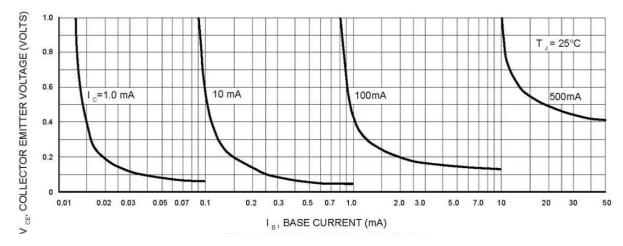


Fig 15. DC Current Gain

Fig 13. Voltage Feedback Ratio

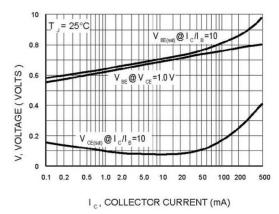




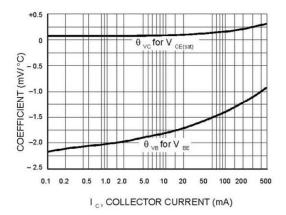




#### Fig 17. "On" Voltages



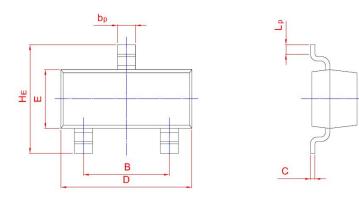
### Fig 18. Temperature Coefficients

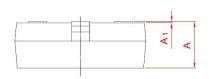




# PACKAGE INFORMATION

Dimension in SOT-23 Package (Unit: mm)





Symbol	Millimeters			
	Min	Max		
A	0.900	1.400		
В	1.780	2.050		
bp	0.350	0.510		
С	0.080	0.190		
D	2.700	3.100		
E	1.200	1.650		
HE	2.100	3.000		
A <sub>1</sub>	0.013	0.100		
Lp	0.200	0.500		



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